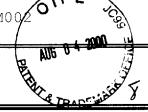


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RECORDATION COVER SHEET **PATENTS**

To the Honorable Commissioner of Patents and Trademarks:

Please record the attached original documents or copies thereof.

1. Name(s) of conveying party(ies):

YAMATO SCIENTIFIC CO., LTD.

2. Name(s) and Address(es) of receiving party(ies):

TOKUYAMA CORPORATION

1-1, Mikage-cho, Tokuyama-shi

Yamaguchi-ken, JAPAN

3. Nature of conveyance: Assignment

Execution Date: June 23, 2000

4A. Patent Application No.(s): 09/243,420

Application execution date: January 20, 1999

4B. Patent No.(s):

5. Name and Address of Party to whom correspondence regarding this document should be mailed:

SMITH, GAMBRELL & RUSSELL, LLP Beveridge, DeGrandi, Weilacher & Young Intellectual Property Group 1850 M Street N.W. (Suite 800) Washington, DC 20036

202 659-2811

6. Total number of applications and patents involved : one

7. Total fee: \$40.00.

(Enclosed. Please charge any deficiency or refund any excess to counsel's deposit account.)

8. Deposit account no.: 02-4300

DO NOT USE THIS SPACE

9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Name of Person Signing: Michael A. Makuch, Reg. No. 32,263

Signature:_ The

Date: August 4, 2000

08/31/2000 NTHAI1 00000078/09243420

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40.00 DP

PATENT REEL: 011030 FRAME: 0829 **ASSIGNMENT**

WHEREAS, YAMATO SCIENTIFIC CO., LTD., a company of Japan, having its

place of business at 1-6, Nihonbashi Honcho 2-chome, Chuo-ku, Tokyo, Japan hereinafter

referred to as ASSIGNOR, is a co-owner, by Assignment dated January 20, 1999, recorded in the

U.S. Patent and Trademark Office on February 3, 1999, and appearing at Reel 9765, Frame 0546

, of the entire right, title and interest in an invention entitled "PRESSURE MOLDING

APPARATUS" and entire right, title and interest in U.S. Patent Application No. 09/243,420,

filed February 3, 1999, in the name of Masatoshi TSUCHIYA et al.:

WHEREAS, TOKUYAMA CORPORATION, a corporation of Japan, whose post

office address is 1-1, Mikage-cho, Tokuyama-shi, Yamaguchi-ken, Japan, referred to as

ASSIGNEE, is desirous of acquiring the entire right, title and interest of ASSIGNOR in and to

the said U.S. patent application and the invention described and claimed therein;

NOW, THEREFORE, in consideration of the sum of \$10.00 paid by the

ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, the

ASSIGNOR has and hereby does sell, assign and transfer to the ASSIGNEE its entire right,

title and interest in and to said U.S. patent application and the invention described and claimed

therein to the full end of the term for which Letters Patent may be granted and hereby authorizes

and requests the Commissioner of Patents and Trademarks to issue the said Letters Patent to said

ASSIGNEE, identified in the recorded Assignment referred to above; and said ASSIGNOR

PATENT REEL: 011030 FRAME: 0830 covenants that it has full right to convey its entire interest herein assigned, and that it has not executed and will not execute any agreements in conflict herewith.

IN TESTIMONY WHEREOF, ASSIGNOR has caused these presents to be signed by a duly authorized officer.

	YAMATO SCIENTIFIC CO., LTD.	
By:	Signature /Schitaled /Schale	, '
	Yoshitaka Komaki	_
	Print Name	
	Managing Director	
	Title	-
	June 23,2000	
	Date	